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PATENT NUMBER and ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10092617	FILING DATE 03/08/2002	CLASS 257-8	SUBCLASS 446	GAU 13725	<u>F</u>	EXAMINE	STELL)
**APPLICANT			Okabe Shota	ro; Sanc	Masaf	umi; Sakai Akira	a;
Hayashi_Ryo;_8	Sugiyama Shuichir	<u>o;</u>	· 				
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	PPLICATIONS VE	RIFIED:					40
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Foreign priority cla	imed	-	s □ no		АТТС	RNEY DOCKE	T NO
35 USC 119 condit Verified and Ackno	ions met wledged Examiners's i		o no		03500	0.016270.	
TTLE : Semico	nductor element, a	ind metho	od of forming s	silicon-ba		T PT. OF COMM./PAT.& TR	A-PTO-436L/Rev 12-04
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NOTICE OF ALLOWANCE MARLED ISSUE FEE		·	CLAIMS ALLOWED					
		Assistant Examiner	Total Claims		Print Claim for O.G			
			DRAWING					
Amount Due	Date Paid	1	Sheets Drwg.	Figs.Drwg	Print Fig.			
		Primary Examiner		<u></u>	1			
TERMINAL		PREPARED FOR ISSUE	Application Examiner					
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